

# Precision Voltage Regulator Controller

### ADP3310

#### **FEATURES**

±1.5% Accuracy Over Line, Load and Temperature Low 800 μA (Typical) Quiescent Current Shutdown Current: 1 μA (Typical) Stable with 10 μF Load Capacitor +2.5 V to +15 V Operating Range Fixed Output Voltage Options: 2.8 V, 3 V, 3.3 V, 5 V

Up to 10 A Output Current

SO-8 Package

49°C to +85°C Ambient Temperature Range Internal Gate to Source Protective Clamp

Current and Thermal Limiting Programmable Current Limit

Foldback Current Limit

APPLICATIONS

Desktop Computers Handheld Instruments

Cellular Telephones
Battery Operated Devices

Solar Powered Instruments
High Efficiency Linear Power Supplies

**Battery Chargers** 

#### GENERAL DESCRIPTION

The ADP3310 is a precision voltage regulator controller that can be used with an external Power PMOS device such as the NDP6020P to form a two chip low dropout linear regulator. The low quiescent current ( $800\,\mu\text{A}$ ) and the Enable feature make this device especially suitable for battery powered systems. The dropout voltage at 1 A is only 70 mV when used with the NDP6020P, allowing operation with minimal headroom and prolonging battery useful life. The ADP3310 can drive a wide range of currents, depending on the external PMOS device used.

Additional features of this device include: high accuracy ( $\pm 1.5\%$ ) over line, load and temperature, gate-to-source voltage clamp to protect the external MOSFET and foldback current limit. A current limit threshold voltage of 50 mV (typ) allows 50 m $\Omega$  of board metal trace resistance to provide a 1 A current limit.

The ADP3310 operates from a wide input voltage range from 2.5 V to 15 V and is available in a small SO-8 package.

#### FUNCTIONAL BLOCK DIAGRAM

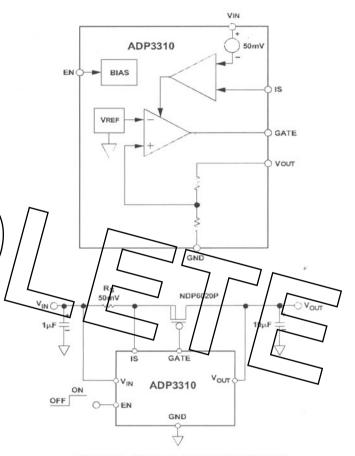


Figure 1. Typical Application Circuit

#### REV. A

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Parameter	Conditions	Symbol	Min	Typ	Max	Units
OUTPUT VOLTAGE ACCURACY (Figure 1)	$V_{IN} = V_{OUT} + 1 \text{ V to } 15 \text{ V}$ $V_{EN} = 2 \text{ V}, I_{OUT} = 10 \text{ mA}$ to 1 A	$V_{OUT}$	-1.5		+1.5	%
QUIESCENT CURRENT		. 001				
Shutdown Mode	$V_{EN} = 0 V$	$I_{GND}$		1	10	μА
Normal Mode	$V_{EN} = 2 \text{ V}, I_{OUT} = 500 \mu\text{A}$	$I_{GND}$		800	1000	μА
GATE TO SOURCE CLAMP VOLTAGE	$V_{OUT} = 0 \text{ V}, V_{IN} = 15 \text{ V}$			8	10	V
GATE DRIVE MINIMUM VOLTAGE				0.7		V
GATE DRIVE CURRENT (SINK/SOURCE)			1			mA
GAIN $\left(\frac{\Delta V_{GS}}{\Delta V_{OUT}}\right)$				80		dB
CURRENT LIMIT THRESHOLD VOLTAGE	V <sub>IN</sub> - V <sub>IS</sub>		40	50	80	mV
LOADREGULATION	I <sub>OUT</sub> = 10 mA to 1 A		-10		10	mV
LINE REGULATION	$V_{IN} = V_{OUT} + 1 \text{ V to } 15 \text{ V}$ $I_{OUT} = 100 \text{ mA}$		-10		10	mV
SHUDDOWN INPUT VOLTAGE	V <sub>IH</sub>	$V_{EN}$	2.0		0.4	V V
SHUTDOWN INFUT CURRENT	$V_{EN} \neq 0 \text{ V to } 5.0 \text{ V}$	I <sub>EN</sub>	-10		+10	μА
Specifications subject to change without notice.  ABSOLUTE MAXIMUM RATINGS*  Input Voltage, $V_{IN}$ Enable Input Voltage 0.3 V to Operating Junction Temperature Range $-40^{\circ}$ Operating Temperature Range $-65^{\circ}$ Storage Temperature Range $-65^{\circ}$ Lead Temperature (Soldering, 10 sec)  Vapor Phase (60 sec)  Infrared (15 sec) $\theta_{JA}$ (4-Layer Board) $\theta_{JA}$ (2-Layer Board	C V <sub>IN</sub> + 0.3 V C to +125°C °C to +85°C C to +150°C +300°C +215°C +220°C +121°C/W +150°C/W					
*This is a stress rating only; operation beyond these limits can ca be permanently damaged.	use the device to					

#### CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADP3310 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



#### ORDERING GUIDE

Output Voltage	Package Option*		
2.8 V	SO-8		
3 V	SO-8		
3.3 V	SO-8		
5 V	SO-8		
	2.8 V 3 V 3.3 V		

<sup>\*</sup>SO = Small Outline. Contact the factory for the availability of other output voltage options from 5 V to 16.5 V.

Refer to the ADP3319 data sheet for 1.8 V and 2.5 V output voltage options. Refer to the ADP3328 data sheet for adjustable output version.

#### PIN CONFIGURATION SO-8



#### PIN FUNCTION DESCRIPTIONS

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Table I. Alternate PMOS Devices

PMOS	NDP6020P IRF7404		Si9434DY	
Manufacturer	Fairchild	IR	Temic	
R <sub>DS(ON)</sub>	$0.075 \Omega @ V_{GS} = -2.5 V$	$0.06 \Omega$ @ $V_{GS} = -2.7 V$	$0.06 \Omega @ V_{GS} = -2.5 V$	
I <sub>D</sub> Continuous @ 25°C	$-27 \text{ A} @ \text{V}_{GS} = -4.5 \text{ V}$	$-5.3 \text{ A} @ \text{V}_{GS} = -4.5 \text{ V}$	-6.4 A	
P <sub>D</sub> @ 25°C	75 W	1.6 W	2.5 W	
Derating Factor	0.5 W/°C	0.011 W/°C	1.6 W @ 70°C	
Package	TO-220	SO-8	SO-8	

## ADP3310-Typical Performance Characteristics (Circuit of Figure 1)

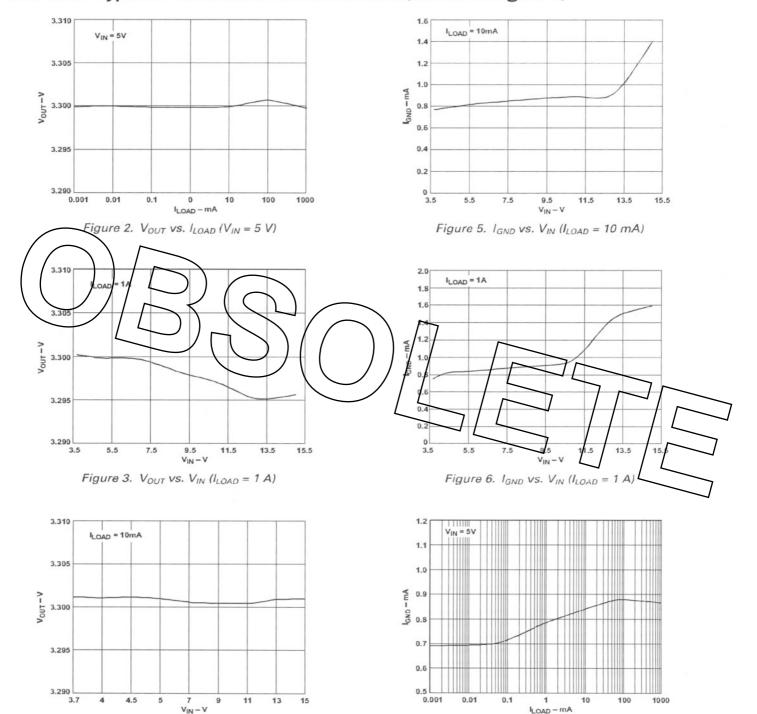


Figure 7.  $I_{GND}$  vs.  $I_{LOAD}$  ( $V_{IN} = 5 V$ )

Figure 4.  $V_{OUT}$  vs.  $V_{IN}$  ( $I_{LOAD} = 10 \text{ mA}$ )

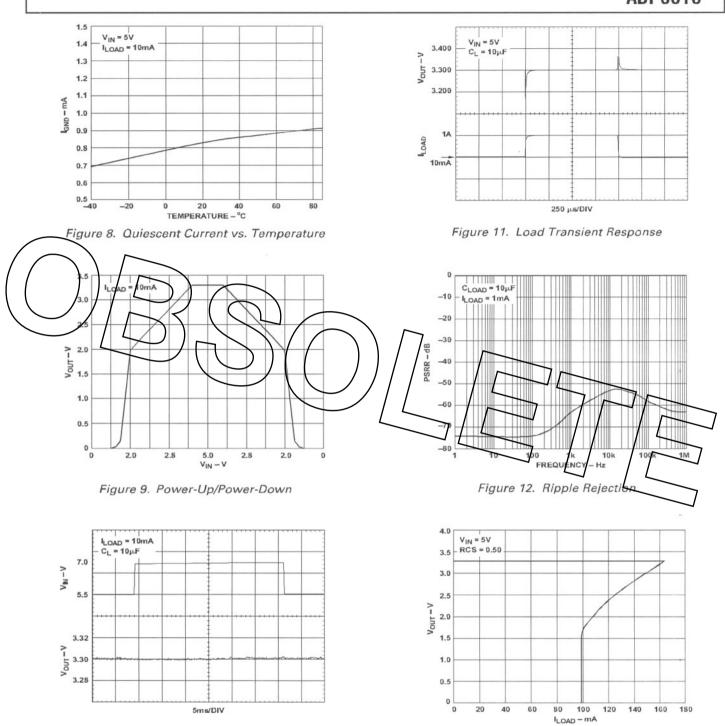


Figure 10. Line Transient Response—(10 µF Load)

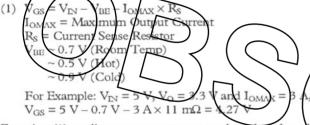
Figure 13. Foldback Current

#### APPLICATION INFORMATION

The ADP3310 is very easy to use. A P-channel power MOSFET and a small capacitor on the output is all that is needed to form an inexpensive ultralow dropout regulator. The advantage of using the ADP3310 controller is that it can drive a pass PMOS FET to provide a regulated output at high current.

#### **FET Selection**

The type and size of the pass transistor are determined by the threshold voltage, input-output voltage differential and load current. The selected PMOS must satisfy the physical and thermal design requirements. Table I shows a partial list of manufacturers providing the PMOS devices. To ensure that the maximum  $V_{GS}$  provided by the controller will turn on the FET at worst case conditions (i.e., temperature and manufacturing tolerances), the maximum available  $V_{GS}$  must be determined. Maximum  $V_{GS}$  is calculated as follows:



Equation (1) applies to a gate-to-source voltage less than it gate to source clamp voltage.

(2) 
$$V_{DS} = V_{DV} - V_{O}$$
  
 $V_{DS} = 5 V - 3.3 V = 1.7 V$ 

If  $V_{IN} \le 5$  V, logic level FET should be considered. If  $V_{IN} > 5$  V, either logic level or standard MOSFET can be used.

The difference between  $V_{IS}$  and  $V_{OUT}$  ( $V_{DS}$ ) must exceed the voltage drop due to the load current and the ON resistance of the FET. As a safety margin, it is recommended to use a MOSFET with a  $V_{GS}$  at least 1.5 times lower than the calculated  $V_{GS}$  value from Equation 1. Also, in the event the circuit is shorted to ground, the MOSFET must be able to conduct the maximum short circuit current. The selected MOSFET must satisfy these criteria; otherwise, a different pass device should be used. If the FET data is not available in the catalogue, contact the FET manufacturer.

#### Thermal Design

The maximum allowable thermal resistance between the FET junction and the highest ambient temperature must be taken into account to determine the type of FET package used. One square inch of PCB copper area as heatsink yields a typical  $\theta_{J\Lambda} \sim 60^{\circ}\text{C/W}$  for the SOT-223 package and  $\theta_{J\Lambda} \sim 50^{\circ}\text{C/W}$  for the SO-8 package. For substantially lower thermal resistances,  $D^2PAK$  or TO-220 type of packages are recommended.

For normal applications, the FET can be directly mounted to the PCB. But, for higher power applications, an external heat sink is required to satisfy the  $\theta_{JA}$  requirement and provide adequate heatsink. Calculating thermal resistance for  $V_{IN}$  = 5 V,  $V_{O}$  = 3.3 V, and  $I_{O}$  = 3 A:

$$\theta_{JA} = \frac{T_J - T_{AMBMAX}}{(V_{DSMAX} \times I_{OMAX})}$$

 $T_J$  = Junction Temperature  $T_{AMBMAX}$  = Maximum Ambient Temperature  $V_{DSMAX}$  = Maximum Drain to Source Voltage

I<sub>OMAX</sub> = Maximum Output Current

$$\theta_{\rm JA} = \frac{125 - 50}{1.7 \times 3} = 14.7 \,{}^{\circ}C/W$$

For such a low  $\theta_{J\Lambda}$ , a P-channel FET from Fairchild, such as NDP6020P in a heatsink mountable TO-220 package, is required. The required external heatsink is determined as follows:

 $\theta_{C\Lambda} = \theta_{J\Lambda} - \theta_{JC}$ 

 $\theta_{CA}$  = Case-to-Ambient Thermal Resistance

 $\theta_{J\Lambda}$  = Junction-to-Ambient Thermal Resistance

 $\theta_{IC}$  = Junction-to-Case Thermal Resistance

 $\theta_{JC} = 2^{\circ}C/W$  for NDP6020P

 $\theta_{CA} = 14.7^{\circ}\text{C/W} - 2^{\circ}\text{C/W} = 12.7^{\circ}\text{C/W}$ 

For a safety margin, select a heatsink with a  $\theta_{CA}$  less than half of the value calculated above to allow extended duration of short circuit. In a natural convection environment, a large heatsink such as 3" length of Type 63020 extrusion from Aavid Engineering is required.

#### **External Capacitors**

The ADP310 is stable with virtually any good quality capacitors (anyCAP<sup>M</sup>), independent of the capacitor's minimum ESR (Effective Series Resistance) value. The actual value of the capacitor and its associated ESR depends on the g<sub>m</sub> and capacitance of the external PMOS device. A 10 µF capacitor at the output is sufficient to ensure stability for up to 10 Å output current. Larger capacitors can be used if high output current surges are anticipated Extremely low ESR capacitors (ESR-0) such as multilayer ceramic or OSCON are preferred because they offer lower ripple on the output. For less demanding requirements, a standard tantalum or even an aluminum electrolytic is used, be sure it meets the temperature requirements because aluminum electrolytic has poor performance over temperature.

#### Shutdown Mode

Applying a TTL high signal to the EN pin or tying it to the input pin will enable the output. Pulling this pin low or tying it to ground will disable the output. In shutdown mode, the controller's quiescent current is reduced to less than  $1~\mu A$ .

#### Gate-to-Source Clamp

An 8 V gate-to-source voltage clamp is provided to protect the MOSFET in the event the output is suddenly shorted to ground. This allows the use of the new, low on-state resistance (R<sub>DSON</sub>) FETs.

#### Short Circuit Protection

The power FET is protected during short circuit conditions with a foldback type of current limiting which significantly reduces the current.

#### **Current Sense Resistor**

Current limit is achieved by setting an appropriate current sense resistor  $(R_S)$  across the current limit threshold voltage. Current limit sense resistor  $R_S$  is calculated as follows:

$$R_{\rm S} = \frac{0.05}{(1.5 \times I_{\rm O})}$$

anyCAP is a trademark of Analog Devices, Inc.

Current Limit Threshold Voltage = 0.05 V Safety Factor = 1.5

Io = Output Current

 $R_{\rm S}$  is not needed in circuits that do not require current limiting. In that case, the  $I_{\rm S}$  pin must be tied to the input pin.

The simplest and cheapest sense resistor for high current applications, (i.e., Figure 1) is a PCB trace. The temperature dependence of the copper trace and the thickness tolerances of the trace must be taken into account in the design. The resistivity of copper has a positive temperature coefficient of +0.39%/°C. Copper's Tempco in conjunction with the proportional-to-absolute temperature (PTAT) current limit voltage can provide an accurate current limit. Table II provides the resistance value for PCB copper traces. Alternately, an appropriate sense resistor such as surface mount sense resistors available from KRL can be

CB-Lay ut for optim ım volt the load as close as possible to the de pins. It is recommended to CIN use dedicated PCB traces to connect the MOSF the positive terminal and ) to t erminal of the e negati load to avoid v the high cu ent carrying PC traces.

Application Circuits
Typical 3 A LDO Circuit

The ADP3310 and a power MOSFET can be used to power the new generation of CPUs and microprocessors from the standard +5 V supply at a very low cost (Figure 14). This circuit provides low dropout, fast switching and high switching load current from 0 A to 3 A. Due to the high switching load current, capacitors with high ripple current carrying capability, such as OSCON or special tantalum capacitors from Sprague (593D), are recommended for the output.

Table II. Printed Circuit Copper Resistance

Conductor Thickness	Conductor Width In	Resistance mΩ/In
1/2 oz/ft <sup>2</sup>	0.025	39.3
(18 µm)	0.050	19.7
	0.100	9.83
	0.200	4.91
	0.500	1.97
1 oz/ft <sup>2</sup>	0.025	19.7
(35 µm)	0.050	9.83
	0.100	4.91
	0.200	2.46
	0.500	0.98
2 oz/ft²	0.025	9.83
(70 µm)	0.050	4.91
	0.100	2.46
	0.200	1.23
	0.500	0.49
3 oz/ft <sup>2</sup>	0.025	6.5
(106 µm)	0.050	3.25
	0.100	1.63
/ /	0.200	0.81
1 1	1 10500	0.325
OSCON T	R2 NDP6020P  Oper 10µF  kill S GATE  ADP3310-3.3  EN GND	3 3 × 220µF

Figure 14. Typical 3 A Low Dropout Regulator Circuit

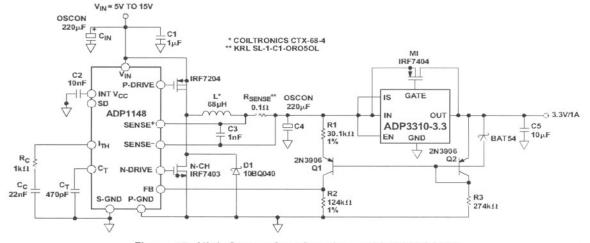


Figure 15. High Current Post Regulator with SOIC PMOS

#### High Current Post Regulator with SOIC PMOS

Post regulation for a switch-mode supply (Figure 15) can be implemented with a PMOS in an SO-8 package to provide a significant reduction in peak-to-peak ripple voltage. A constant dropout voltage in conjunction with low quiescent current yield a more efficient voltage regulator that can significantly extend battery life. The bottom waveform of Figure 16 is the output of the switching regulator. The top waveform is the output of the post regulator.

In applications where cost is a higher concern than efficiency, a resistor divider can be used to provide feedback instead of the current mirror. Power efficiency is lower in cases of light loads.

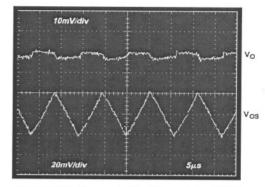
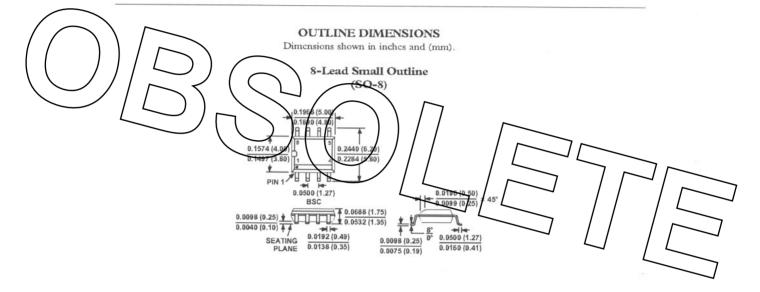


Figure 16. Pre-and Post-Regulated Voltage



# OTC ALERT

GOLD...GOLD...GOLD
USCorp HAS STRUCK GOLD...

SYMBOL:

\$0.35

Recent Price Market Cap:

9,000,000

# ALERT...

# Symbol: USCS

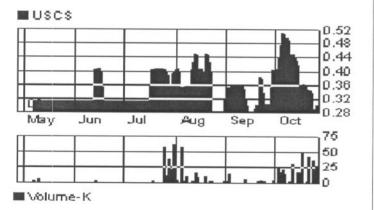
# Recent Price: 0.35

#### THE BUSINESS

It has been over twenty years since the price of gold has shown such exciting upside action and potential. It has been just as long since conditions were right for an American Company to develop an American Gold asset. The Twin Peaks Mine in West-Central Arizona is such a property. The Twin Peaks Mines is about 80 miles North West of Phoenix, Arizona and Amiles south-east of Bagdad, Arizona. Bagdad is the site of the Phelps Dodge open primine. Phelps Dodge employs 515 people.

primarily producing copper (247 million pounds in 2000), molybdenum, gold and silver.

USCorp is a fully reporting public corporation trading on the Over The Counter Bulletin Board, Symbol USCS. USCorp's wholly owned subsidiary USMetals, Inc., owns the mining leases to 141 lode mining claims that constitute the Twin Peaks Mine. USCorp is an exploration and development company that has begun test production.



#### 1985 - Appraisal and Valuation

The Late Mr. N. H. Carouso, former President of Geo-Processing, Inc., was retained to make an economic valuation of the Twin Peaks Property. The following is a statement from Mr. Carouso's report: "It is felt that an early cash flow can be expected. Based on mining to a depth of 100 feet, the gross dollar potential using only 30% of the areas evaluated, could be \$280,836,000.00. Mr Caruso's report was based on a spot price of \$325/oz / gold and \$6.00/oz. / silver."

#### 2002 - Appraisal and Valuation

Mr. Scott Spooner, Senior Geologist of Spooner & Associates reported 3,690,782 estimated reserve dunces of gold. Spooner reported silver estimated reserves at approximately 18,400,000 ounces at five ounces of silver for every ounce of gold. These estimates verify Caruso's proven findings

#### Recent News Releases

7-22-03 – USCorp announces proven drilling program confirms proven gold reserves.

8-06-03 - USCorp announces completion of Twin Peaks Gold Mine "Phase One Plan of Operations"

USCorp's mission is to become a large and successful commercially producing, metals and minerals company. USCorp's growth strategy is geared towards additional future property acquisitions.

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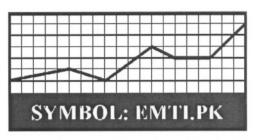
# Wall Street Stock Alerts

Symbol OTCPK: EMTI.PK
Recent Price \$0.215
Target Price : \$1.00

STRONG BUY

News Flash:

Alarmingly, kidnapping in North America has risen to an all-time high of over 800 persons per day! Kinder Finder and Gadget Finder addresses an urgent societal need that is vital to every parent or guardian. Do not miss this trade!



### Environmental Tech • OTCPK: EMTI.PK • Recent Price: \$ 0.215

### Company Info: EMTI.PK

Environmental Technologies' products currently being developed for specific market applications include short- and long-range detection devices that can be hidden in clothing, or on valuables, and that will emit signals to loved ones or owners of articles. The technology provides a capability that is ideal for families living in fear of their children being kidnapped, or of having elderly family members suffering from dementia or any other form of memory loss wander off aimlessly without their loved one's knowledge.

Alarmingly, kidnapping in North America has risen to an all-time high of over 800 persons per day! Another promising application, "Find-A-Shipment," will enable real-time tracking and up-to the-minute delivery progress for shippers needing to maximize their just-in-time delivery service.

The Company also announced recently that it is pursuing the introduction of an embedded device in credit cards, passports, etc., that will pinpoint the location of lost or stolen cards in real time. We believe that our product range admirably addresses these growing security needs, and that the marketplace will enthusiastically welcome the Finder technology.

The technology provides a capability that is ideal for families living in fear of their children being kidnapped, or of having elderly family members, suffering from dementia or any other form of memory loss, wander off aimlessly without their loved one's knowledge.

#### **BREAKING NEWS!!**

TUCSON, Ariz., Sept. 9, 2003 (PRIMEZONE)
Environmental Technologies Inc. (Other OTC: EMTI.PK
News) is pleased to announce they have received the prototypes for its first two FINDER SECURITY DEVICES, the Gadget Finder and Kinder Finder, ahead of schedule, following which the devices will undergo independent testing this fall.

The Company is engaged in discussions with several ecognized testing/engineering firms and expects to enter into an agreement by month-end whereby formal testing will be carried out preparatory to the commencement of production design and engineering

Gadget Finder -- represents an inexpensive way to prevent the loss or theft of portable electronic gadgets such as cell phones, PDAs, laptops, CD players, etc. The device, which encompasses leading-edge GPS, wireless, and RFID technology, allows the owner to instantly locate the missing device using a pocket-held wireless unit. As well, an audible beep will alert the owner whenever the device reaches a stipulated distance (i.e., 30 feet) from the owner.

Kinder Finder -- consists of a tiny device hidden on a child's person that will allow the parent to pinpoint the location of that child to within 1,000 square feet anywhere in the world at any time. If a parent and child get separated in public, the parent can immediately determine, from a pocket-held unit or medallion, the direction in which the child has wandered off, and the distance to the child. With kidnappings and reports of missing children having risen to an all time high in the US, Kinder Finder addresses an urgent need that is vital to every parent or guardian.

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